

VRRM	IF (TC≤135℃)	QC
650V	9A	18nC

Applications:

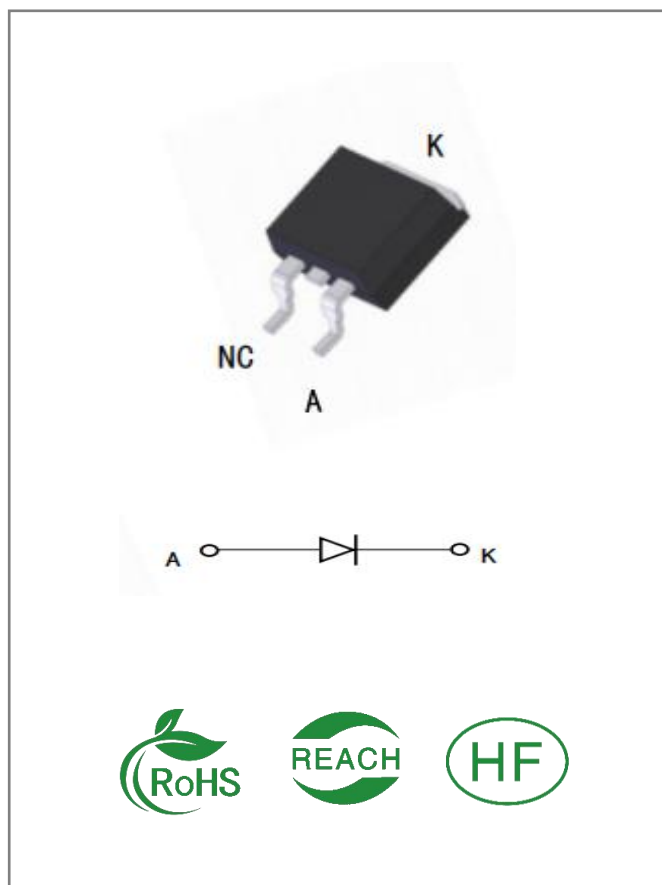
- Switch Mode Power Supplies
- Power Factor Correction
- Motor drive, PV Inverter, Wind Power Station

Features:

- Zero Reverse Recovery Current
- Zero Forward Recovery Voltage
- Positive Temperature Coefficient on VF
- Temperature-independent Switching
- 175°C Operating Junction Temperature

Benefits:

- Replace Bipolar with Unipolar Device
- Reduction of Heat Sink Size
- Parallel Devices Without Thermal Runaway
- Essentially No Switching Losses



Ordering Information

Part Number	Package	Marking	Packing	Qty.
RSS06065D	TO-252	RSS06065D	Tape&reel	2500 PCS

Maximum Ratings (TJ= 25°C unless otherwise specified)

Symbol	Parameter	Value	Unit	Test Conditions	Note
VRRM	Repetitive Peak Reverse Voltage	650	V	TC = 25°C	
VRSM	Surge Peak Reverse Voltage	650	V	TC = 25°C	
VR	DC Blocking Voltage	650	V	TC = 25°C	
IF	Forward Current	20 9 6	A	TC ≤ 25°C TC ≤ 135°C TC ≤ 153°C	Fig. 3
IFSM	Non-Repetitive Forward Surge Current	66 57	A	TC = 25°C, tp = 10ms, Half Sine Wave TC = 110°C, tp = 10ms, Half Sine Wave	
IFRM	Repetitive Peak Forward Surge Current	60	A	TC = 25°C, tp = 10ms, Half Sine Wave	
Ptot	Power Dissipation	87	W	TC = 25°C	Fig. 4
TC	Maximum Case Temperature	153	°C		
TJ,TSTG	Operating Junction and Storage Temperature	-55 to 175	°C		

Electrical Characteristics (TJ= 25°C unless otherwise specified)

Symbol	Parameter	Typ.	Max.	Unit	Test Conditions	Note
VF	Forward Voltage	1.34 1.67	1.5 -	V	IF = 6A, TJ = 25°C IF = 6A, TJ = 175°C	Fig.1
IR	Reverse Current	1.2 4.5	50 -	μA	VR = 650V, TJ = 25°C VR = 650V, TJ = 175°C	Fig.2
C	Total Capacitance	261 35 33	/	pF	VR = 1V, TJ = 25°C, f = 1MHz VR = 200V, TJ = 25°C, f = 1MHz VR = 400V, TJ = 25°C, f = 1MHz	Fig.5
QC	Total Capacitive Charge	18	/	nC	VR = 400V,	Fig.6
Ec	Capacitance Stored Energy	2.9		uJ	VR = 400V,	Fig.7

Thermal Characteristics (TJ= 25°C unless otherwise specified)

Symbol	Parameter	Typ.	Unit	Note
RθJC	Thermal Resistance from Junction to Case	1.73	°C/W	Fig.8

Typical Feature Curve

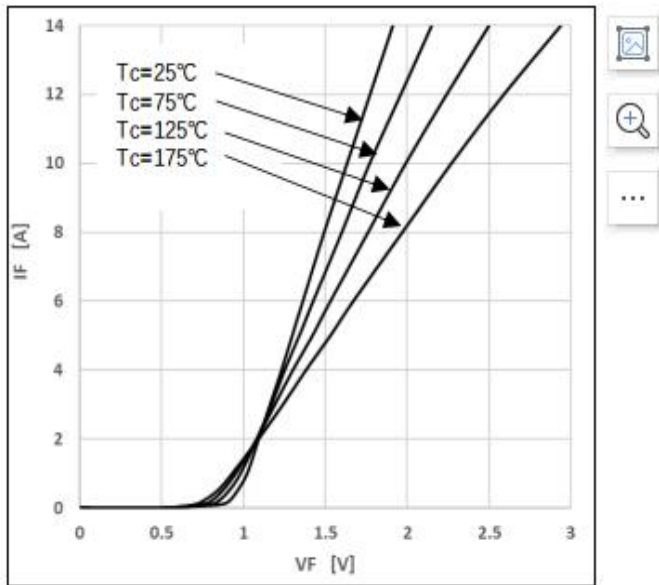


Figure 1 Forward Characteristics

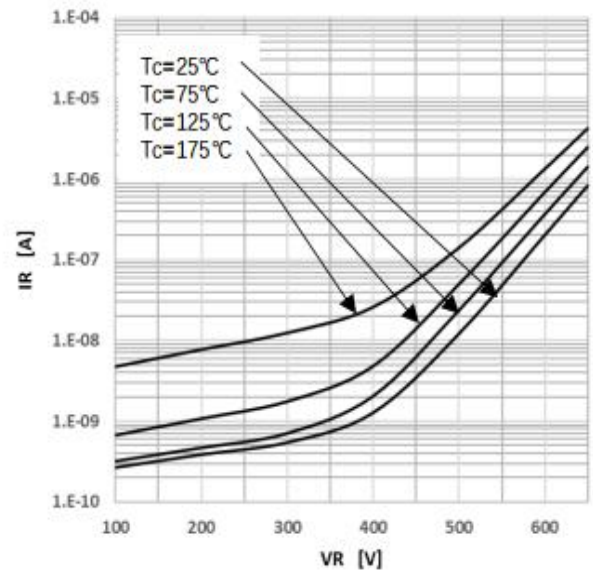


Figure 2 Reverse Characteristics

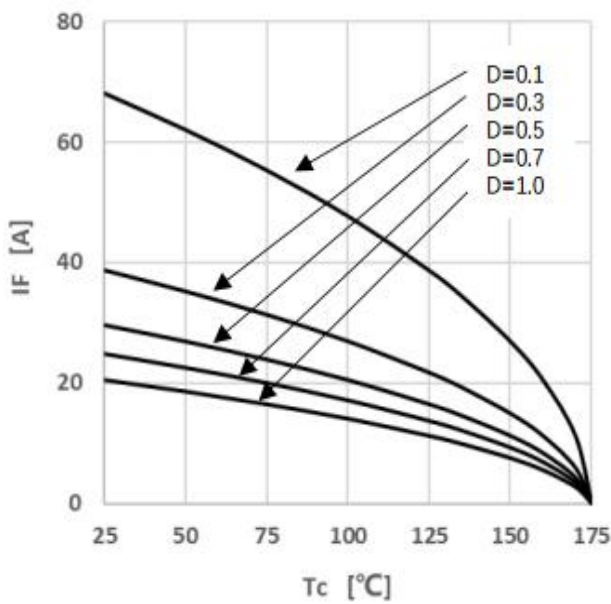


Figure 3 Peak Forward Current Derating

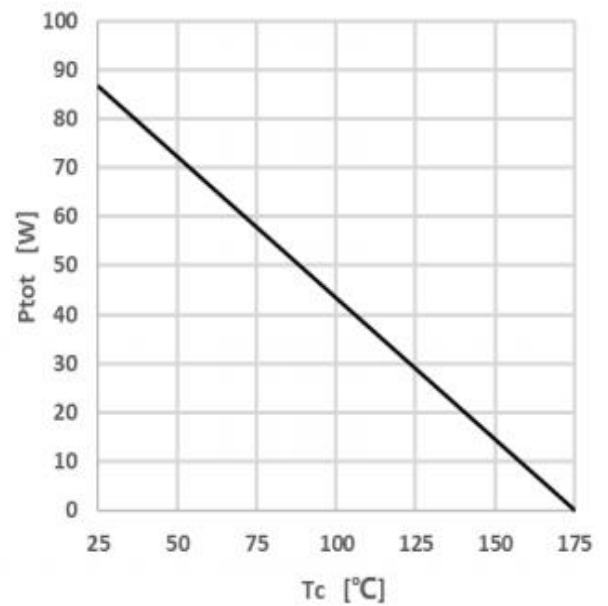


Figure 4 Power Dissipation

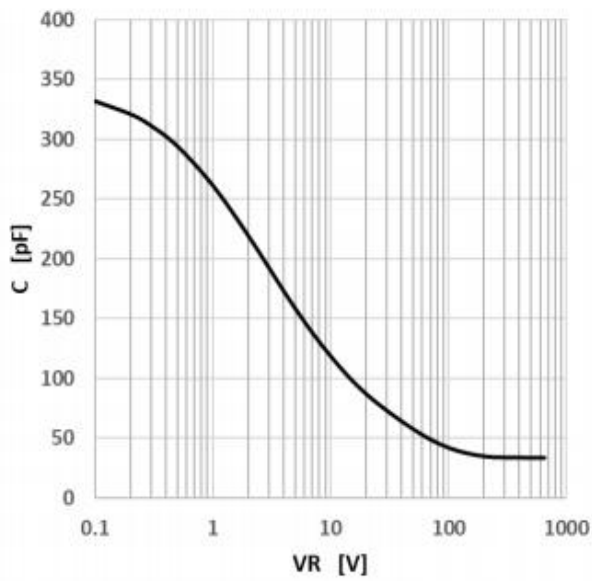


Figure 5 Capacitance vs. Reverse Voltage

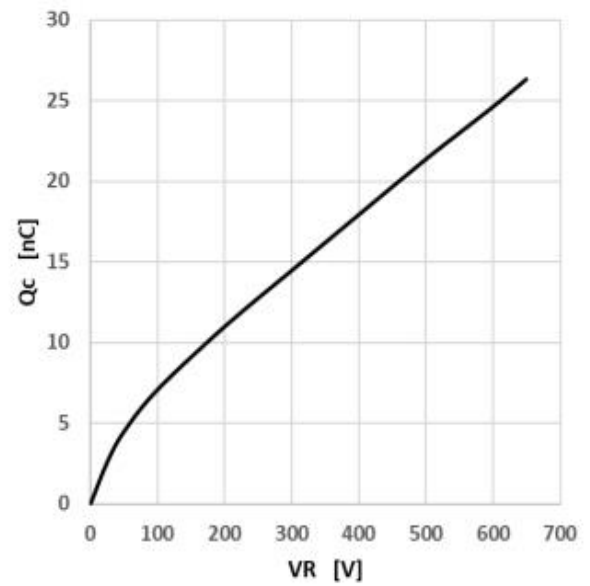


Figure 6 Capacitance Charge vs. Reverse Voltage

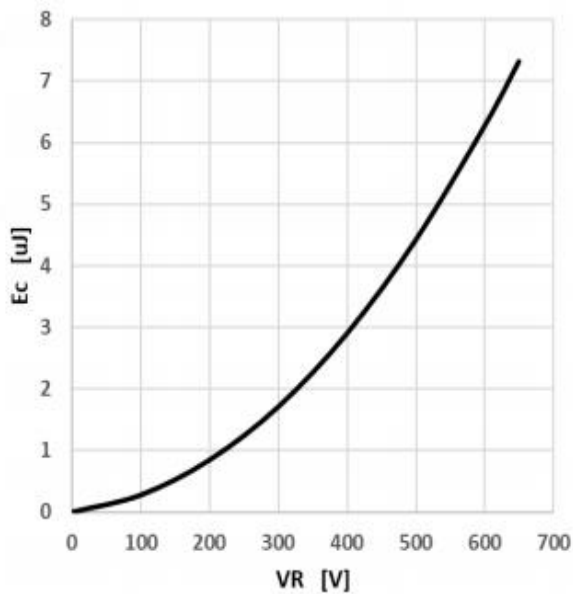


Figure 7 Capacitance Stored Energy

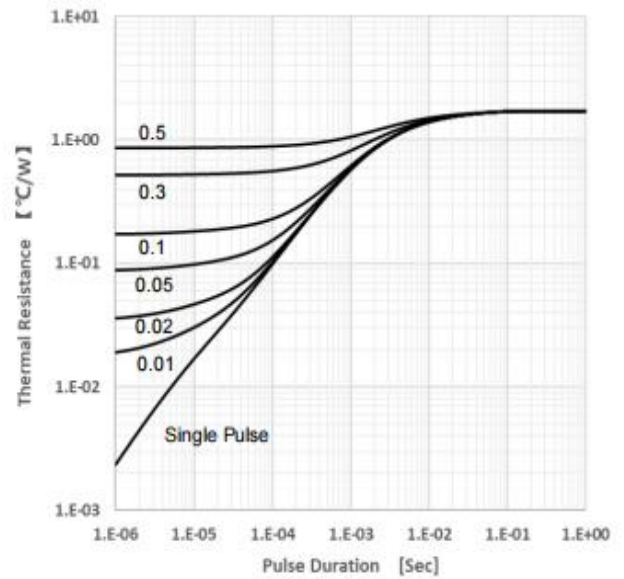
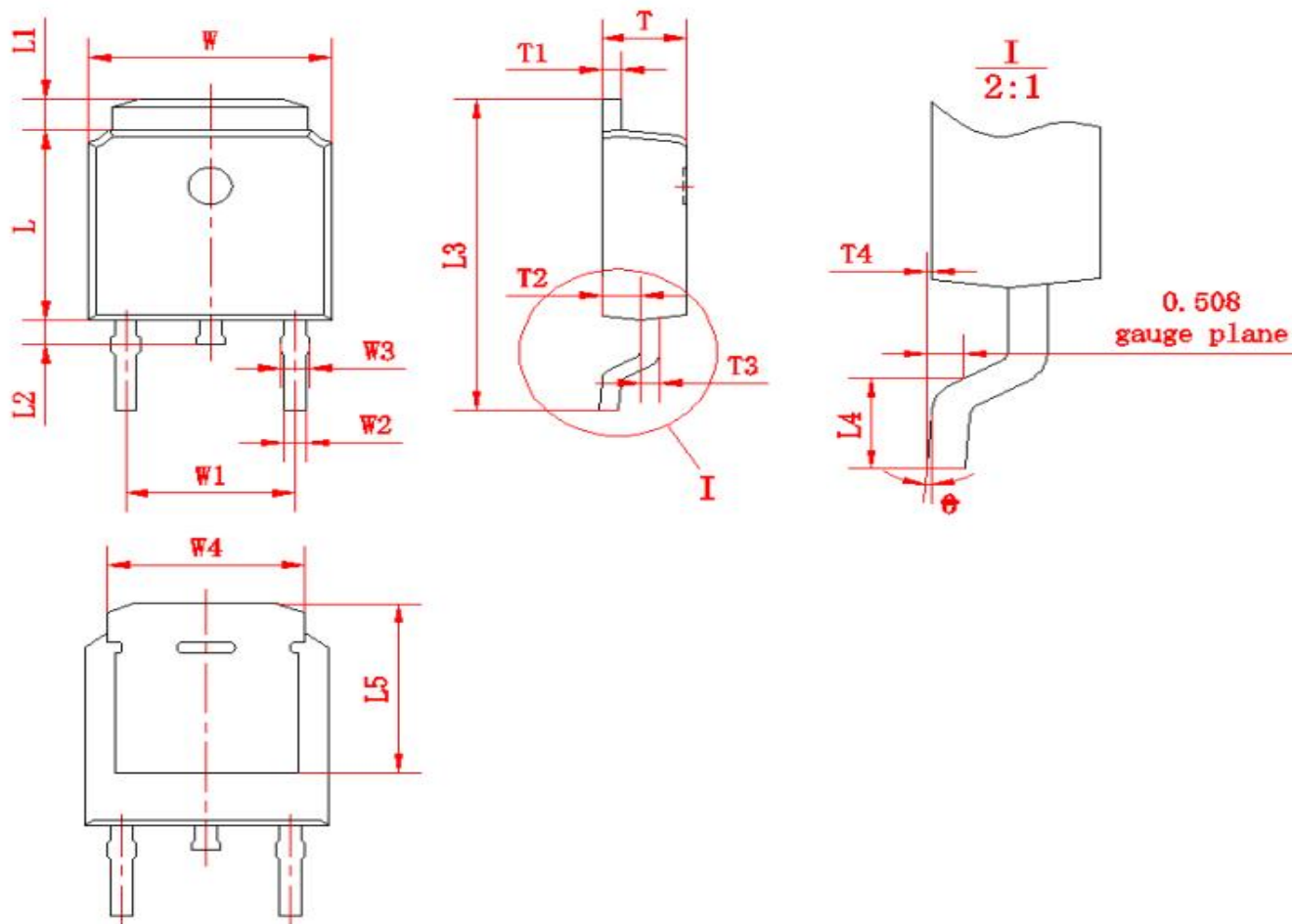


Figure 8 Transient Thermal Impedance

Package outline drawing(TO-252 Unit: mm)



符号	尺寸		符号	尺寸		符号	尺寸	
	Min	Max		Min	Max		Min	Max
W	6.50	6.70	L1	0.80	1.20	T1	0.48	0.58
W1	(4.572)		L2	0.60	1.00	T2	0.95	1.15
W2	0.6	0.8	L3	9.70	10.30	T3	0.48	0.58
W3	0.68	0.88	L4	1.30	1.70	T4	0.00	0.12
W4	(5.3)		L5	(5.20)		0	0	8
L	6.00	6.20	T	2.20	2.40			

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